CDECLEICATION										
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SPEC. NO.: PS-51088-2	XXXXX-XXX RE	VISION: A								
PRODUCT NAME:0.	5mm BTB CONN. SMT TYPE									
PRODUCT NO: 510	PRODUCT NO: 51088 Series ; 51089 Series									
PREPARED: CHECKED: APPROVED:										
Zhu, Wei	Xu, Zhi Yong	Xu, Zhi Yong								
2019/10/15	DATE: 2019/10/15	2019/10/15								

**2013/02/20** TR-FM-73015L

Ac	Aces P/N: 51088 series ; 51089 series									
TITLE:	: 0.5 MM BOARD TO	BOARD CONN. SM	ІТ ТҮРЕ							
RELEASE	DATE: 2019/08/08	REVISION: A		ECN No: ECN-003835	PAGE: 2 OF 10					
1 2										
3	APPLICABLE DC	CUMENTS								
4	REQUIREMENTS	<b>.</b>			4					
5	PERFORMANCE	PERFORMANCE								
6	INFRARED REFLOW CONDITION									
7	PRODUCT QUAL	JFICATION AND	TEST SF	EQUENCE						
8	MATED HEIGHT									

# ACES

Aces P/N: 51088 series ; 51089 series

TITLE: 0.5 MM BOARD TO BOARD CONN. SMT TYPE

RELEASE DATE: 2019/08/08

REVISION: A ECN No: ECN-003835

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## **1** Revision History

Rev.	ECN #	Revision Description	Prepared	Date
А	ECN-003835	FOR APD1080320 NEW REV	Zhu Wei	2019/10/15

	Connectors										
	Aces P/N: 51088 series ; 51089 series										
Т	TITLE: 0.5 MM BOARD TO BOARD CONN. SMT TYPE										
REL	LEASE DATE: 2019/08/08         REVISION: A         ECN No: ECN-003835         PAGE: 4 OF 10										
2	2 SCOPE This specification covers performance, tests and quality requirements for 0.5 mm pitch board to board connectors SMT TYPE										
3	APPLICABLE DOCUMENTS										
	EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION										
4	REQUIREMENTS										
	4.1 Design and Construction										
	4.1.1 Product shall be of design, construction and physical dimensions specified on										
	applicable product drawing. 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.										
	4.2 Materials and Finish										
	<ul> <li>4.2.1 Contact: High performance copper alloy (Phosphor Bronze)</li> <li>Finish: (a) Contact Area: Refer to the drawing.</li> <li>(b) Under plate: Refer to the drawing.</li> <li>(c) Solder area: Refer to the drawing.</li> </ul>										
	4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0										
	4.3 Ratings										
	<ul><li>4.3.1 Working Voltage Less than 36 Volts</li><li>4.3.2 Voltage: 60 Volts AC/DC</li></ul>										
	4.3.3 Current: 0.5 Amperes Max. (per pin)										
	10 Amperes Max. (All pins can carry) 4.3.4 Operating Temperature : -40℃ to +85℃										
	Page 4										
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10		Aces P/N: 51088 s	eries ; 51089 series		
TLE	E: 0.5 MM BOARD TO B	OARD CONN. SMT TYPE			
AS	E DATE: 2019/08/08 R	EVISION: A ECN No: E	CN-003835 PAGE: 5 OF		
<b>D</b> .	<b>f</b>				
	erformance				
5.1	. Test Requirements and I	Procedures Summary			
	Item	Requirement	Standard		
			Visual, dimensional and functional		
	Examination of Product	applicable product drawing and	per applicable quality inspection		
		specification.	plan.		
		ELECTRICAL			
	ltem	Requirement	Standard		
	Low Level Contact Resistance	80 m Ω Max. per contact	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max.		
			(EIA-364-23)		
	Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals.		
	Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	(EIA-364-21) 150 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)		
	Temperature rise	$30^\circ\!\mathrm{C}$ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)		
		MECHANICAL			
	Item	Requirement	Standard		
	Durability	50 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min.		
			(EIA-364-09) Operation Speed :		

Mating

0.1Kgf MIN.

Mating/Unmating Forces

Terminal / Housing

**Retention Force** 

(Rcpt. CONN.)

0.08Kgf(Max.) /Per Pin

Unmating 0.006Kgf(Min.)/Per Pin 25.4 ± 3 mm/minute..

(EIA-364-13)

housing.

mate/unmate connector.

Measure the force required to

Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute.

On the terminal assembled in the

ICES

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MECHANICAL									
ltem	Item Requirement Standard								
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)							
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)							

ENVIRONMENTAL							
Item Requirement Standard							
Resistance to Reflow	See Product Qualification and Test	Pre Heat ∶ 150°C~180°C,					
Soldering Heat	(Lead Free)	60~120sec.					
		Heat $:$ 230 $^{\circ}$ C Min., 40sec Min.					
		Peak Temp. ÷ 260°∁Max,					
		10sec Max.					
		Mated Connector to follow					
		condition for 5 cycles.					
Thermal Shock	See Product Qualification and Test						
	Sequence Group 4	-40 +0/-3 ℃, 30 minutes					
		+85 +3/-0 ℃, 30 minutes					
		(EIA-364-32, test condition I)					
		Mated Connector					
l luma altere	See Product Qualification and Test	40°C, 90~95% RH,					
Humidity	Sequence Group 4	120 hours.					
		(EIA-364-31,Condition A, Method II)					
	See Product Qualification and Test	Mated connectors to temperature					
Temperature life	Sequence Group 5	life at 85° $\mathbb C$ for 96 hours.					
	ocquence croup o	(EIA-364-17, Test condition A)					

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#### TITLE: 0.5 MM BOARD TO BOARD CONN. SMT TYPE

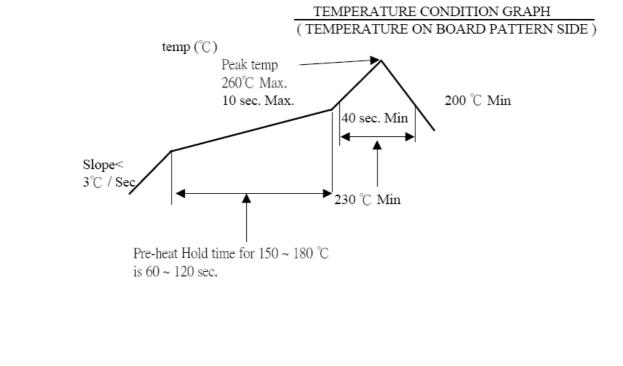
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	20000				
Salt Spray (Only For Gold Plating)	See Product Qualification and Tes Sequence Group 6	Mated connectors to 5% salt- solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 3 u" for 48 hours (III) Gold plating 5 u" for 96 hours. (EIA-364-26)			
H2S resistance	After 48 Hours Contact resistance 80 m $\Omega$ Max.	Conformed to JEIDA-38-1984 Bath temperature 40±2°C Gas concentration 3±1ppm Humidity 75 to 80%RH			
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)			
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.			

## 6 INFRARED REFLOW CONDITION

### 6.1. RECOMMENDED REFLOW TEMPERATURE CONDITION



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7	PRODUCT QUALIFICATION AND TEST SEQUENCE											
	Test Group											
	Test or Examination	1	2	3	4	5	6	7	8	9	10	11
							Sequ					
	Examination of Product	1,3	1	1	1、7	1、6	1、4	1、4	1,3		1,3	1,3
	Low Level Contact Resistance		2、6	2、5	2 \ 8	2 \ 7	2、5	2 \ 5				4
	Insulation Resistance				3、9	3、8						
	Dielectric Withstanding Voltage				4 \ 10	4 \ 9						
	Temperature rise	2										
	Mating / Unmating Forces		3 \ 5									
	Durability		4									
	Vibration			3								
	Shock (Mechanical)			4								
	Thermal Shock				5							
	Humidity				6							
	Temperature life					5						
	Salt Spray(Only For Gold Plating)						3					
	H2S resistance							3				
	Solder ability								2			
	Terminal / Housing Retention Force (Rcpt. CONN.)									1		
	Hand Soldering Temperature Resistance										2	
	Resistance to Soldering Heat											2
	Sample Size	4	4	4	4	4	4	4	4	4	4	4

		stors 5			Aces P/N:	51088 series	; 51089 sei	ries			
Т	TITLE: 0.5 MM BOARD TO BOARD CONN. SMT TYPE										
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8	8 Mated Height										
				PLUG							
		Mated	Height	51089							
		RCPT	51088	9.40							